

# EC3125TA10ET-155.520M

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## REGULATORY COMPLIANCE (Data Sheet downloaded on Oct 26, 2016)


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## ITEM DESCRIPTION

155.520MHz  $\pm 25$ ppm -40°C to +85°C

## ELECTRICAL SPECIFICATIONS

|                                 |                                                                                                                                                                                                                                        |
|---------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Nominal Frequency               | 155.520MHz                                                                                                                                                                                                                             |
| Frequency Tolerance/Stability   | $\pm 25$ ppm Maximum (Inclusive of all conditions: Calibration Tolerance at 25°C, Frequency Stability over the Operating Temperature Range, Supply Voltage Change, Output Load Change, First Year Aging at 25°C, Shock, and Vibration) |
| Aging at 25°C                   | $\pm 5$ ppm/year Maximum                                                                                                                                                                                                               |
| Operating Temperature Range     | -40°C to +85°C                                                                                                                                                                                                                         |
| Supply Voltage                  | 5.0Vdc $\pm 5\%$                                                                                                                                                                                                                       |
| Input Current                   | 50mA Maximum                                                                                                                                                                                                                           |
| Output Voltage Logic High (Voh) | 2.4Vdc Minimum with TTL Load, Vdd-0.5Vdc with HCMOS Load                                                                                                                                                                               |
| Output Voltage Logic Low (Vol)  | 0.4Vdc Maximum with TTL Load, 0.5Vdc Maximum with HCMOS Load                                                                                                                                                                           |
| Rise/Fall Time                  | 5nSec Maximum (0.4Vdc to 2.4Vdc w/TTL Load, 20% to 80% of waveform w/HCMOS Load)                                                                                                                                                       |
| Duty Cycle                      | 50 $\pm 5$ (%) (Measured at 1.4Vdc with TTL Load or with HCMOS Load)                                                                                                                                                                   |
| Load Drive Capability           | 10TTL Load or 15pF HCMOS Load Maximum                                                                                                                                                                                                  |
| Output Logic Type               | CMOS                                                                                                                                                                                                                                   |
| Control Voltage                 | 2.5Vdc $\pm 2.0$ Vdc                                                                                                                                                                                                                   |
| Frequency Deviation             | $\pm 100$ ppm Minimum                                                                                                                                                                                                                  |
| Linearity                       | $\pm 10\%$ Maximum                                                                                                                                                                                                                     |
| Transfer Function               | Positive Transfer Characteristic                                                                                                                                                                                                       |
| Absolute Clock Jitter           | $\pm 200$ pSec Maximum                                                                                                                                                                                                                 |
| One Sigma Clock Period Jitter   | $\pm 50$ pSec Maximum                                                                                                                                                                                                                  |
| Start Up Time                   | 10mSec Maximum                                                                                                                                                                                                                         |
| Storage Temperature Range       | -55°C to +125°C                                                                                                                                                                                                                        |

## ENVIRONMENTAL & MECHANICAL SPECIFICATIONS

|                              |                                       |
|------------------------------|---------------------------------------|
| Fine Leak Test               | MIL-STD-883, Method 1014, Condition A |
| Gross Leak Test              | MIL-STD-883, Method 1014, Condition C |
| Lead Integrity               | MIL-STD-883, Method 2004              |
| Mechanical Shock             | MIL-STD-202, Method 213, Condition C  |
| Resistance to Soldering Heat | MIL-STD-202, Method 210               |
| Resistance to Solvents       | MIL-STD-202, Method 215               |
| Solderability                | MIL-STD-883, Method 2003              |
| Temperature Cycling          | MIL-STD-883, Method 1010              |
| Vibration                    | MIL-STD-883, Method 2007, Condition A |

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MECHANICAL DIMENSIONS (all dimensions in millimeters)



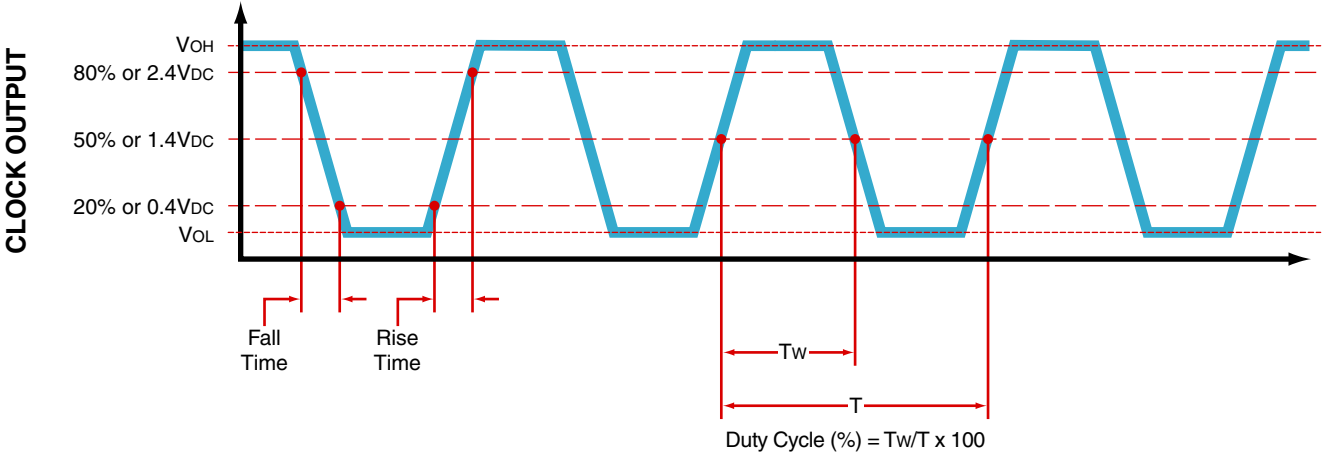
| PIN | CONNECTION         |
|-----|--------------------|
| 1   | Control Voltage    |
| 7   | Ground/Case Ground |
| 8   | Output             |
| 14  | Supply Voltage     |

| LINE | MARKING                                                                                        |
|------|------------------------------------------------------------------------------------------------|
| 1    | ECLIPTEK                                                                                       |
| 2    | EC31<br>EC31=Product Series                                                                    |
| 3    | 155.52M                                                                                        |
| 4    | XXYYZZ<br>XX=Ecliptek Manufacturing<br>Code<br>Y=Last Digit of the Year<br>ZZ=Week of the Year |

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OUTPUT WAVEFORM



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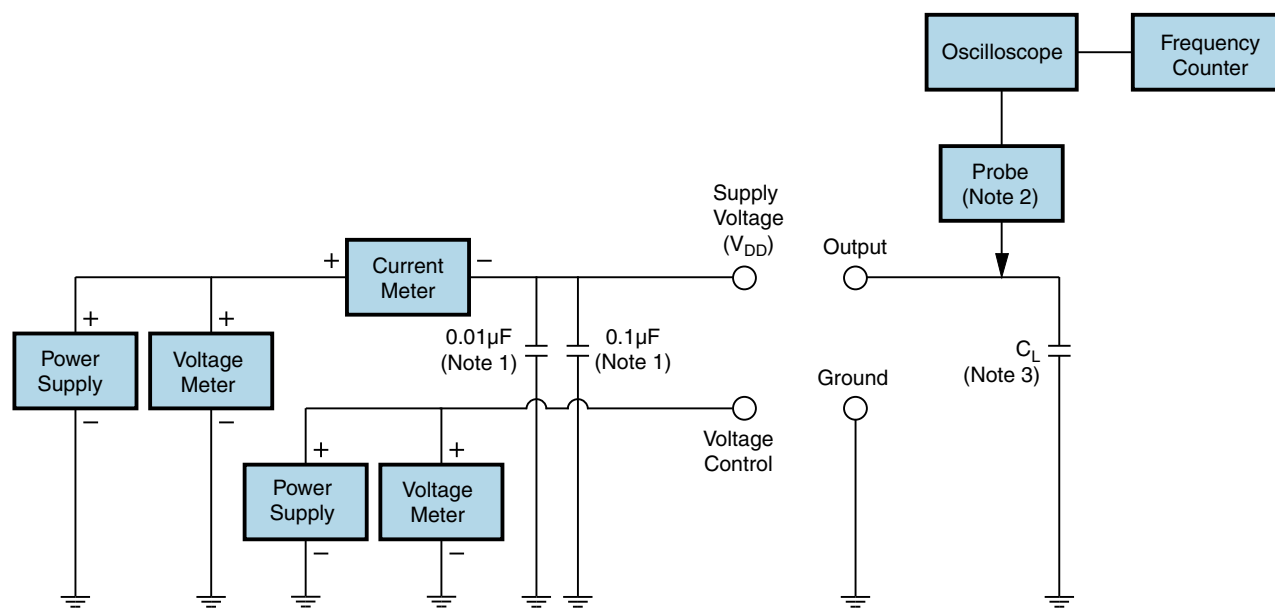
Test Circuit for TTL Output

| Output Load Drive Capability | R <sub>L</sub> Value (Ohms) | C <sub>L</sub> Value (pF) |
|------------------------------|-----------------------------|---------------------------|
| 10TTL                        | 390                         | 15                        |
| 5TTL                         | 780                         | 15                        |
| 2TTL                         | 1100                        | 6                         |
| 10LSTTL                      | 2000                        | 15                        |
| 1TTL                         | 2200                        | 3                         |

Table 1: R<sub>L</sub> Resistance Value and C<sub>L</sub> Capacitance Value Vs. Output Load Drive Capability



- Note 1: An external 0.1µF low frequency tantalum bypass capacitor in parallel with a 0.01µF high frequency ceramic bypass capacitor close to the package ground and V<sub>DD</sub> pin is required.
- Note 2: A low capacitance (<12pF), 10X attenuation factor, high impedance (>10Mohms), and high bandwidth (>300MHz) passive probe is recommended.
- Note 3: Capacitance value C<sub>L</sub> includes sum of all probe and fixture capacitance.
- Note 4: Resistance value R<sub>L</sub> is shown in Table 1. See applicable specification sheet for 'Load Drive Capability'.
- Note 5: All diodes are MMBD7000, MMBD914, or equivalent.

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**Test Circuit for CMOS Output**

Note 1: An external 0.01µF ceramic bypass capacitor in parallel with a 0.1µF high frequency ceramic bypass capacitor close (less than 2mm) to the package ground and supply voltage pin is required.

Note 2: A low capacitance (<12pF), 10X attenuation factor, high impedance (>10Mohms), and high bandwidth (>300MHz) passive probe is recommended.

Note 3: Capacitance value  $C_L$  includes sum of all probe and fixture capacitance.

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Recommended Solder Reflow Methods



High Temperature Solder Bath (Wave Solder)

|                                     |                                                                                                                                          |
|-------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------|
| Ts MAX to Tl (Ramp-up Rate)         | 3°C/Second Maximum                                                                                                                       |
| Preheat                             |                                                                                                                                          |
| - Temperature Minimum (Ts MIN)      | 150°C                                                                                                                                    |
| - Temperature Typical (Ts TYP)      | 175°C                                                                                                                                    |
| - Temperature Maximum (Ts MAX)      | 200°C                                                                                                                                    |
| - Time (ts MIN)                     | 60 - 180 Seconds                                                                                                                         |
| Ramp-up Rate (Tl to Tp)             | 3°C/Second Maximum                                                                                                                       |
| Time Maintained Above:              |                                                                                                                                          |
| - Temperature (Tl)                  | 217°C                                                                                                                                    |
| - Time (tL)                         | 60 - 150 Seconds                                                                                                                         |
| Peak Temperature (Tp)               | 260°C Maximum for 10 Seconds Maximum                                                                                                     |
| Target Peak Temperature (Tp Target) | 250°C +0/-5°C                                                                                                                            |
| Time within 5°C of actual peak (tp) | 20 - 40 Seconds                                                                                                                          |
| Ramp-down Rate                      | 6°C/Second Maximum                                                                                                                       |
| Time 25°C to Peak Temperature (t)   | 8 Minutes Maximum                                                                                                                        |
| Moisture Sensitivity Level          | Level 1                                                                                                                                  |
| Additional Notes                    | Temperatures shown are applied to back of PCB board and device leads only. Do not use this method for product with the Gull Wing option. |

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Recommended Solder Reflow Methods



Low Temperature Infrared/Convection 185°C

|                                     |                                                                                                               |
|-------------------------------------|---------------------------------------------------------------------------------------------------------------|
| Ts MAX to Tl (Ramp-up Rate)         | 5°C/Second Maximum                                                                                            |
| Preheat                             |                                                                                                               |
| - Temperature Minimum (Ts MIN)      | N/A                                                                                                           |
| - Temperature Typical (Ts TYP)      | 150°C                                                                                                         |
| - Temperature Maximum (Ts MAX)      | N/A                                                                                                           |
| - Time (ts MIN)                     | 60 - 120 Seconds                                                                                              |
| Ramp-up Rate (Tl to Tp)             | 5°C/Second Maximum                                                                                            |
| Time Maintained Above:              |                                                                                                               |
| - Temperature (Tl)                  | 150°C                                                                                                         |
| - Time (tL)                         | 200 Seconds Maximum                                                                                           |
| Peak Temperature (Tp)               | 185°C Maximum                                                                                                 |
| Target Peak Temperature (Tp Target) | 185°C Maximum 2 Times                                                                                         |
| Time within 5°C of actual peak (tp) | 10 Seconds Maximum 2 Times                                                                                    |
| Ramp-down Rate                      | 5°C/Second Maximum                                                                                            |
| Time 25°C to Peak Temperature (t)   | N/A                                                                                                           |
| Moisture Sensitivity Level          | Level 1                                                                                                       |
| Additional Notes                    | Temperatures shown are applied to body of device. Use this method only for product with the Gull Wing option. |

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**Recommended Solder Reflow Methods****Low Temperature Solder Bath (Wave Solder)**

|                             |                    |
|-----------------------------|--------------------|
| TS MAX to TL (Ramp-up Rate) | 5°C/Second Maximum |
|-----------------------------|--------------------|

**Preheat**

|                                |                 |
|--------------------------------|-----------------|
| - Temperature Minimum (TS MIN) | N/A             |
| - Temperature Typical (TS TYP) | 150°C           |
| - Temperature Maximum (TS MAX) | N/A             |
| - Time (ts MIN)                | 30 - 60 Seconds |

|                         |                    |
|-------------------------|--------------------|
| Ramp-up Rate (TL to TP) | 5°C/Second Maximum |
|-------------------------|--------------------|

**Time Maintained Above:**

|                    |                     |
|--------------------|---------------------|
| - Temperature (TL) | 150°C               |
| - Time (tL)        | 200 Seconds Maximum |

|                       |               |
|-----------------------|---------------|
| Peak Temperature (TP) | 245°C Maximum |
|-----------------------|---------------|

|                                     |                                              |
|-------------------------------------|----------------------------------------------|
| Target Peak Temperature (TP Target) | 245°C Maximum 1 Time / 235°C Maximum 2 Times |
|-------------------------------------|----------------------------------------------|

|                                     |                                                       |
|-------------------------------------|-------------------------------------------------------|
| Time within 5°C of actual peak (tp) | 5 Seconds Maximum 1 Time / 15 Seconds Maximum 2 Times |
|-------------------------------------|-------------------------------------------------------|

|                |                    |
|----------------|--------------------|
| Ramp-down Rate | 5°C/Second Maximum |
|----------------|--------------------|

|                                   |     |
|-----------------------------------|-----|
| Time 25°C to Peak Temperature (t) | N/A |
|-----------------------------------|-----|

|                            |         |
|----------------------------|---------|
| Moisture Sensitivity Level | Level 1 |
|----------------------------|---------|

|                  |                                                                                                                                          |
|------------------|------------------------------------------------------------------------------------------------------------------------------------------|
| Additional Notes | Temperatures shown are applied to back of PCB board and device leads only. Do not use this method for product with the Gull Wing option. |
|------------------|------------------------------------------------------------------------------------------------------------------------------------------|

**Low Temperature Manual Soldering**

185°C Maximum for 10 Seconds Maximum, 2 times Maximum. (Temperatures listed are applied to device leads only. This method can be utilized with both Gull Wing and Non-Gull Wing devices.)

**High Temperature Manual Soldering**

260°C Maximum for 5 Seconds Maximum, 2 times Maximum. (Temperatures listed are applied to device leads only. This method can be utilized with both Gull Wing and Non-Gull Wing devices.)